



Material Content Data Sheet



Sales Product Name		BFP 182R E7764		Issued		29. August 2013		
MA#		MA000783616						
Package		PG-SOT143-4-6		Weight*		11.06 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	noble metal	gold	7440-57-5	0.002	0.02		163	
	non noble metal	tin	7440-31-5	0.000	0.00		42	
	inorganic material	silicon	7440-21-3	0.013	0.12	0.14	1208	1413
leadframe	non noble metal	nickel	7440-02-0	1.673	15.12		151211	
	non noble metal	iron	7439-89-6	2.310	20.88	36.00	208816	360027
wire	noble metal	gold	7440-57-5	0.017	0.16	0.16	1567	1567
encapsulation	organic material	carbon black	1333-86-4	0.104	0.94		9440	
	inorganic material	antimonytrioxide	1309-64-4	0.157	1.42		14160	
	plastics	brominated resin	-	0.196	1.77		17700	
	plastics	epoxy resin	-	1.632	14.75		147498	
	inorganic material	silicondioxide	60676-86-0	4.438	40.12	59.00	401195	589993
leadfinish	non noble metal	tin	7440-31-5	0.217	1.96	1.96	19581	19581
plating	noble metal	silver	7440-22-4	0.303	2.74	2.74	27419	27419
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com